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(54) **RADIATION-TO-GENERATOR SYSTEM FOR SPACE APPLICATIONS**

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ABSTRACT

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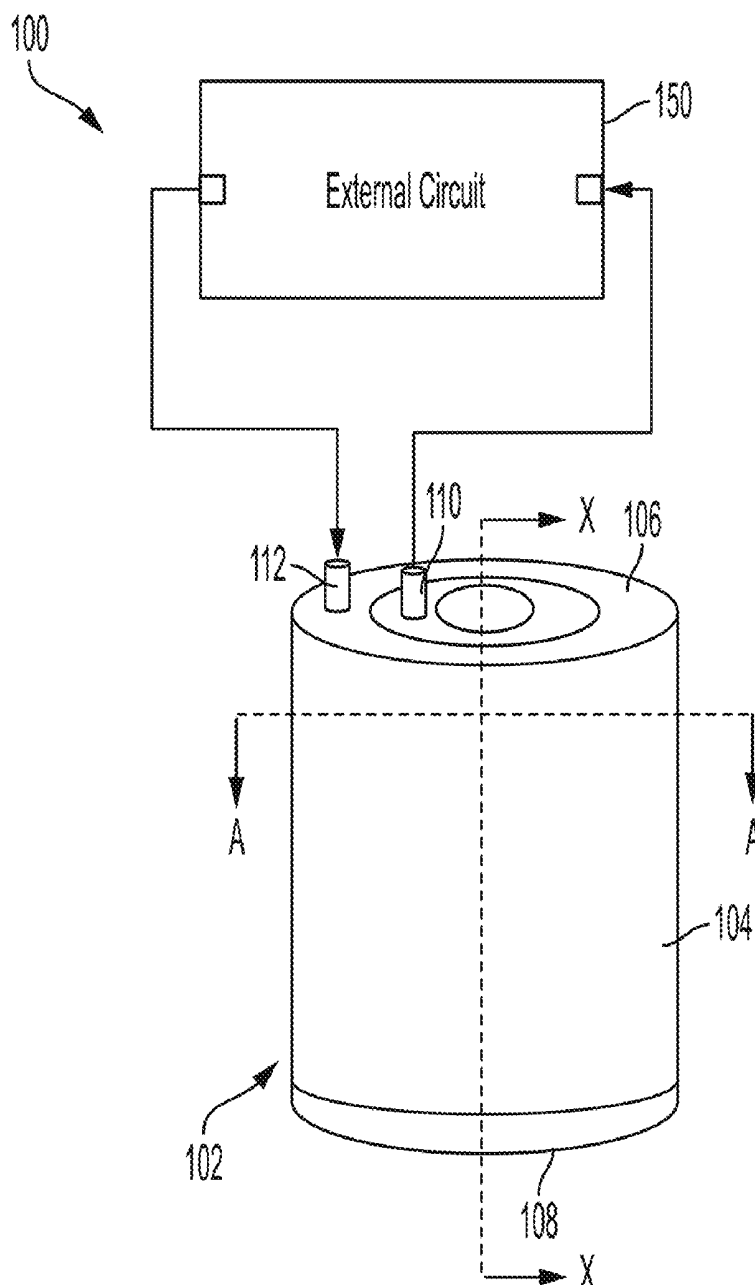
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A radiation-to-generator (RTG) system includes an externally shielded cylindrical betavoltaic battery having side-walls extending between an upper surface and a bottom surface. An external power electronic system is connected to the betavoltaic battery to receive power. The betavoltaic battery is configured to convert energy produced from radioisotope beta-decay to electricity that is configured to power the external power electronic system.



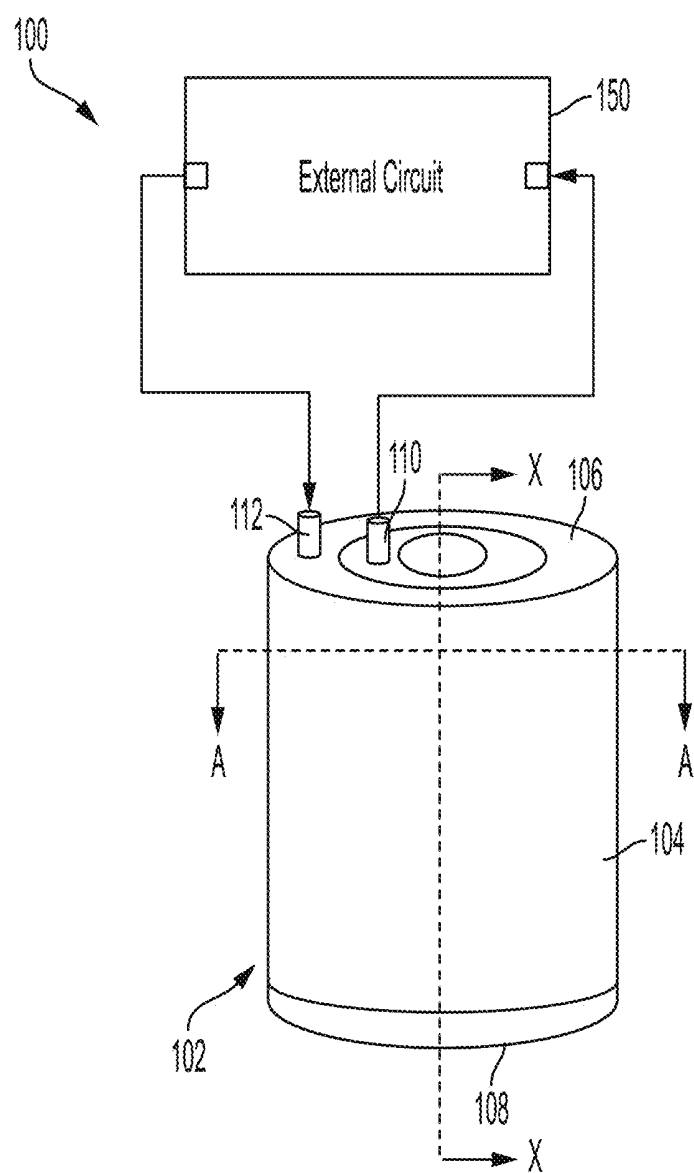
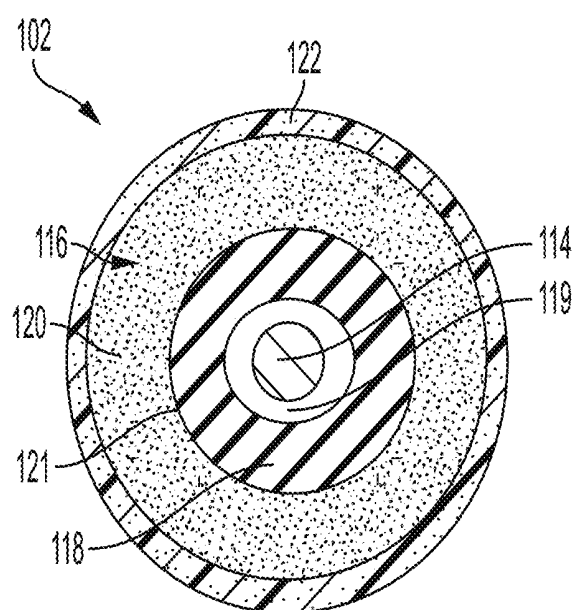
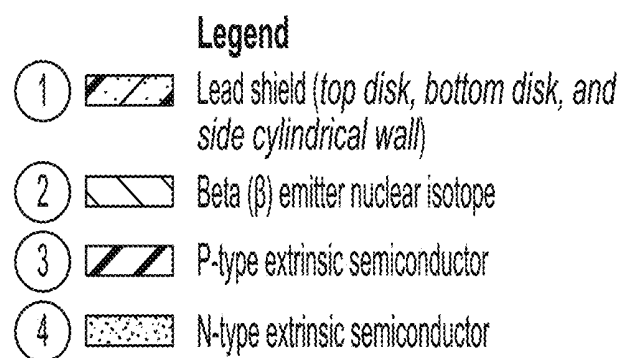






FIG. 1



Section A-A

FIG. 2

- Legend**
- ①  Lead shield (top disk, bottom disk, and side cylindrical wall)
 - ②  Beta (β) emitter nuclear isotope
 - ③  P-type extrinsic semiconductor
 - ④  N-type extrinsic semiconductor

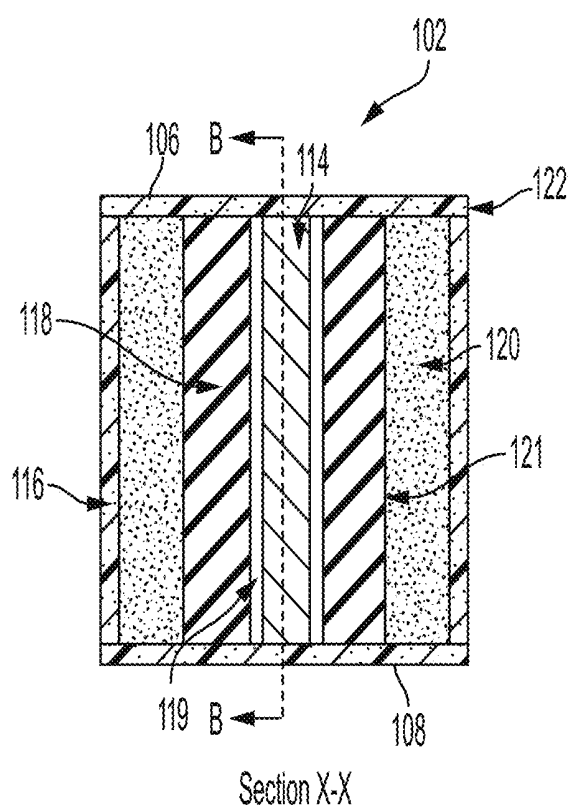
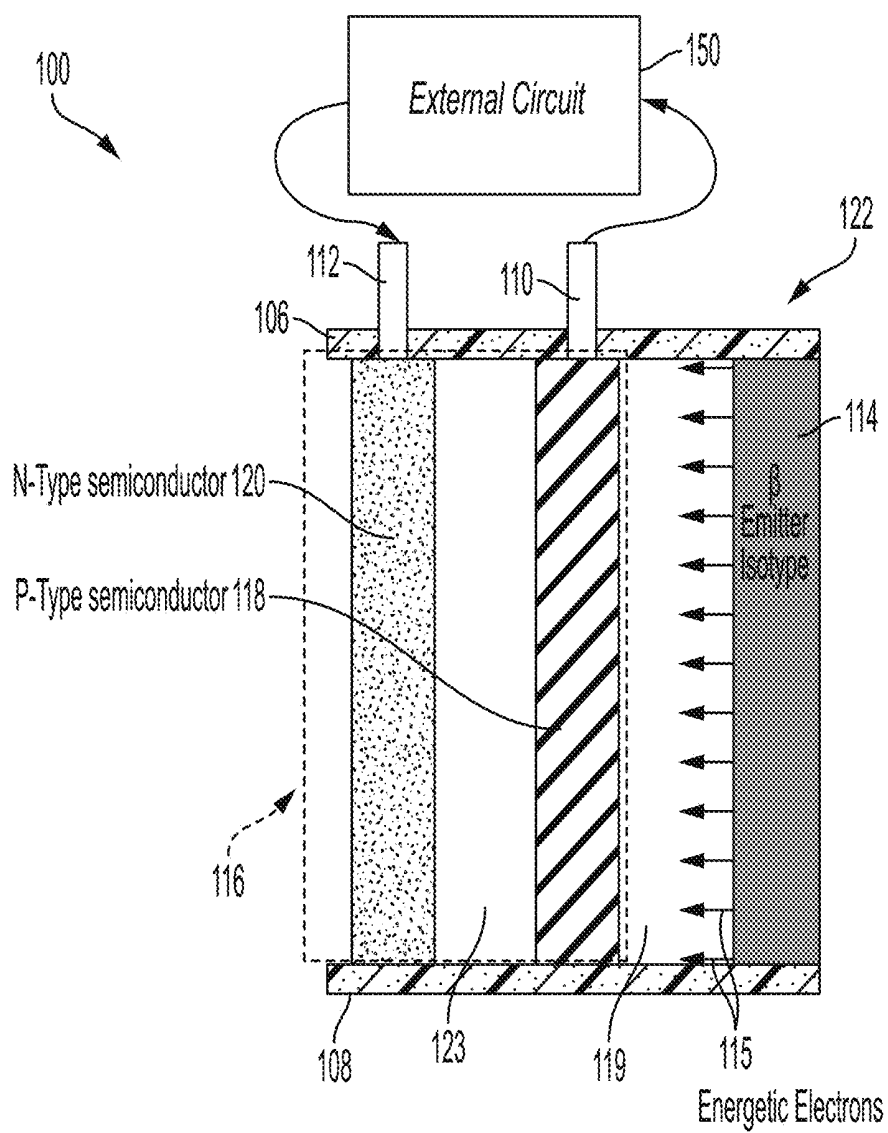


FIG. 3



Section B-B

FIG. 4

RADIATION-TO-GENERATOR SYSTEM FOR SPACE APPLICATIONS

BACKGROUND

[0001] The present disclosure is generally related to power generation systems, and more specifically, to a radiation-to-generator system for space applications.

[0002] Advances in aerospace technologies have facilitated an increase in orbiting distances from Earth and long durations of deep space missions (e.g., missions to the Moon, Mars, and beyond). Long-missions of crewed and uncrewed space vehicles in deep space exploration as well as low earth orbit (LEO) missions require reliable supply of electricity and long service life (e.g., in the range of a few months to a few years) to power the remote electronic components. Also, heating the electronic devices in the deep space (at or below minus 245° F.) is a necessity.

Radiation belts such as the Van-Allen belts can destroy the solar photovoltaic (solar PV) panels typically used for electricity generation in space vehicles by harvesting sun radiation. Also, solar PV would not function in space darkness far from the sun.

BRIEF SUMMARY

[0003] According to a non-limiting embodiment, a radiation-to-generator (RTG) system comprises a betavoltaic (BV) battery having cylindrical sidewalls extending between an upper surface and a bottom surface. An external power electronic system is connected to the betavoltaic battery to receive power. The betavoltaic battery is configured to convert energy produced from radioisotope beta-decay to electricity that is configured to power the external power electronic system.

[0004] In addition to one or more aspects of the system disclosed herein or as an alternate, the system (e.g., betavoltaic battery) comprises a beta-particles source extending along a center axis from a first end to an opposing second end; a semiconductor device including a first-type extrinsic semiconductor surrounding the beta-particles source, and a second-type extrinsic semiconductor surrounding the first-type extrinsic semiconductor and the beta-particles source; and a radioactive shield housing surrounding the second-type extrinsic semiconductor, the first-type extrinsic semiconductor, and the beta-particles source.

[0005] In addition to one or more aspects of the system disclosed herein or as an alternate, the radioactive shield housing includes cylindrical sidewalls extending between an upper surface and a bottom surface, the upper and bottom surfaces extending radially about a center axis to define a cylindrical configuration of the betavoltaic battery.

[0006] In addition to one or more aspects of the system disclosed herein or as an alternate, the first-type extrinsic semiconductor is a p-type semiconductor and the second-type extrinsic semiconductor is an n-type semiconductor.

[0007] In addition to one or more aspects of the system disclosed herein or as an alternate, the first-type extrinsic semiconductor separated from the beta-particles source to define an annular gap therebetween.

[0008] In addition to one or more aspects of the system disclosed herein or as an alternate, the second-type extrinsic semiconductor is coupled to the first-type extrinsic semiconductor to define a p-n junction.

[0009] In addition to one or more aspects of the system disclosed herein or as an alternate, the first-type extrinsic semiconductor and the second-type extrinsic semiconductor each include a porous structure to receive electron collisions.

[0010] In addition to one or more aspects of the system disclosed herein or as an alternate, the first-type extrinsic semiconductor and the second-type extrinsic semiconductor are each doped with impurity atoms.

[0011] In addition to one or more aspects of the system disclosed herein or as an alternate, the radioactive shield housing includes a thin layer of high-density polyethylene (HDPE) deposited on an outer surface thereof.

[0012] In addition to one or more aspects of the system disclosed herein or as an alternate, the betavoltaic battery further comprising a first electrode that is electrically connected to the first-type extrinsic semiconductor and an input of the external power electronic system, and a second electrode that is electrically connected to the second-type extrinsic semiconductor and an output of the external power electronic system.

[0013] In addition to one or more aspects of the system disclosed herein or as an alternate, the beta-particles source includes a beta emitter nuclear isotope characterized by a long half-life to provide long service life of the battery suitable for space applications.

[0014] In addition to one or more aspects of the system disclosed herein or as an alternate, the beta emitter nuclear isotope produces electrons in response to realizing radioisotope beta-decay, and wherein the betavoltaic battery converts kinetic energy of the electrons to the electricity.

[0015] In addition to one or more aspects of the system disclosed herein or as an alternate, the power electronic system comprises a data communication system.

[0016] According to another non-limiting embodiment, a betavoltaic battery comprises a beta-particles source, a semiconductor device, and a radioactive shield housing. The betavoltaic battery extends along a center axis from a first end to an opposing second end. The semiconductor device includes a first-type extrinsic semiconductor surrounding the beta-particles source, and a second-type extrinsic semiconductor surrounding the first-type extrinsic semiconductor and the beta-particles source. The radioactive shield housing surrounds the second-type extrinsic semiconductor, the first-type extrinsic semiconductor, and the beta emitter nuclear isotope. The radioactive shield housing includes cylindrical sidewalls extending between an upper surface and a bottom surface. The upper and bottom surfaces extend radially about a center axis to define a profile of the betavoltaic battery.

[0017] In addition to one or more aspects of the system disclosed herein or as an alternate, the radioactive shield housing includes cylindrical sidewalls extending between an upper surface and a bottom surface.

[0018] In addition to one or more aspects of the system disclosed herein or as an alternate, the first-type extrinsic semiconductor is a p-type semiconductor and the second-type extrinsic semiconductor is an n-type semiconductor.

[0019] In addition to one or more aspects of the system disclosed herein or as an alternate, the first-type extrinsic semiconductor separated from the beta-particles source to define an annular gap therebetween.

[0020] In addition to one or more aspects of the system disclosed herein or as an alternate, the second-type extrinsic

semiconductor is coupled to the first-type extrinsic semiconductor to define a p-n junction.

[0021] In addition to one or more aspects of the system disclosed herein or as an alternate, the first-type extrinsic semiconductor and the second-type extrinsic semiconductor each include a porous structure to receive electron collisions.

[0022] In addition to one or more aspects of the system disclosed herein or as an alternate, the first-type extrinsic semiconductor and the second-type extrinsic semiconductor are each doped with impurity atoms.

BRIEF DESCRIPTION OF THE DRAWINGS

[0023] The following descriptions should not be considered limiting in any way. With reference to the accompanying drawings, like elements are numbered alike:

[0024] FIG. 1 depicts a radiation-to-generator system according to a non-limiting embodiment of the present disclosure;

[0025] FIG. 2 is top cross-sectional view of a betavoltaic battery shown in FIG. 1 taken along line A-A;

[0026] FIG. 3 is a cross-sectional view of the betavoltaic battery shown in FIG. 1 taken along line X-X; and

[0027] FIG. 4 is a cross-sectional view of the betavoltaic battery shown in FIG. 3 taken along line B-B.

DETAILED DESCRIPTION

[0028] A detailed description of one or more embodiments of the disclosed apparatus and method are presented herein by way of exemplification and not limitation with reference to the FIGS. 1 through 4).

[0029] Various non-limiting embodiments described herein provide a betavoltaic (BV) battery configured to convert energy produced from radioisotope beta-decay to electricity configured to power an external power electronic system. The betavoltaic battery is capable of generating electricity and heat to support LEO as well as deep space applications. In one or more non-limiting embodiments, the heat generated by the betavoltaic battery (BV) can be produced by emitted high-energy electrons as they collide with the lattice of the semiconductor material that surrounds the beta-particles emitter. The emitted electrons dissipate their kinetic energy, in the form of thermal energy, into the semiconductor causing its temperature to rise. The heat generated from the BV device can be used to heat, via conductive and radiative heat transfer, the power electronic board or device attached to or in the vicinity to the BV battery. In one or more non-limiting embodiments, the BV battery includes a wide-bandgap (WBG), porous solid-state semiconductor that is protected by a radiation-resistant housing e.g. a radiation shield), which allows the BV battery to outperform solar power cells due to their inability to function when spacecraft orbits pass through radiation belts (such as the Van Allen belts) and during long periods of darkness.

[0030] In one or more non-limiting embodiments, energetic beta particles emitted from the decay of radioactive isotopes impinge on the semiconductor device to generate electron-hole pairs by impact ionization. The impingement of one beta particle can create multiple electron-hole pairs through a series of interaction. The electron-hole pairs diffuse to the depletion region of the p-n junction or Schottky junction defined by the semiconductor device, and are separated to form free holes and electrons by the built-in

electric field. The charges drift in the semiconductor layer and holes and electrons are collected at the anode and cathode electrodes, respectively. Hence, the electrons kinetic energy of the emitted beta particles is converted to electrical energy, which can be used to power the connected various electronic circuit boards and/or devices included in the external power electronic system.

[0031] With reference to FIG. 1, a radiation-to-generator (RTG) system **100** is illustrated according to a non-limiting embodiment of the present disclosure. The RTG system **100** includes a betavoltaic battery **102** and an external power electronic system **150** configured to receive power from the betavoltaic battery **102**. In one or more non-limiting embodiments, the BV battery **102** is configured to convert energy produced from radioisotope beta-decay to electricity configured to power the power electronic system **150**.

[0032] The betavoltaic (BV) battery **102** includes cylindrical sidewalls **104** extending between an upper surface **106** and a bottom surface **108**. According to one or more non-limiting embodiments, the upper and bottom surfaces **106** and **108** extend radially about a center axis (X-X) to define a cylindrical profile having circular or tubular sidewalls.

[0033] The power electronic system **150** is electrically connected to the betavoltaic battery **102** to receive generated electrical power. The power electronic system **150** can include various types of systems including, but not limited to remote sensors, printed circuit boards (PCB), micro-electromechanical systems (MEMS), micro-actuators, etc.

[0034] In one or more non-limiting embodiments, the betavoltaic battery **102** includes a first electrode **110** and a second electrode **112**. A first end of the first and second electrodes **110** can be connected to a semiconductor device utilized by the betavoltaic battery **102** to produce the converted electricity. A second end of the first electrode **110** can be connected to an input **152** of the power electronic system **150**, while a second end of the second electrode **112** is electrically connected to an output **154** of the power electronic system **150**. In this manner, the converted electricity output from the betavoltaic battery **102** can power the power electronic system **150**.

[0035] Turning now to FIGS. 2, 3 and 4, various cross-sectional views depict the betavoltaic battery **102** included in the RTG system **100** according to one or more non-limiting embodiments. The betavoltaic battery **102** includes a beta-particles source **114**, a semiconductor device **116**, and a radioactive shield housing **122**.

[0036] The beta-particles source **114** extends along a center axis (B-B) from an upper end disposed adjacent the upper surface **106** to an opposing second end disposed adjacent the lower surface **108**. In one or more non-limiting embodiments, the beta-particles source **114** includes a beta-emitter nuclear isotope that produces high-energy electrons in response to realizing radioisotope beta-decay. Various types of beta emitter nuclear isotopes can be used to implement the beta-particles source **114** including, but not limited to, Tritium ($^3\text{T}_1$), Nickel ($^{63}\text{Ni}_{28}$), Krypton ($^{85}\text{Kr}_{36}$), Strontium ($^{90}\text{Sr}_{38}$), and Ruthenium ($^{106}\text{Ru}_{44}$). Table 1 below lists various characteristics of beta-decay radioactive isotopes with long service lives suitable for space applications, along with their respective half-lives ranging from 1 year up to about 100 years.

TABLE 1

Name of Radioactive Isotope (Only Beta Decay)	Half-Life (year)	Maximum Energy of Emitted Beta Particles (KeV)	Average Energy of Emitted Beta Particles (KeV)	Specific Power of Isotope (W/gram)	Specific Activity of Isotope (Curie/gram)
Tritium ($^3\text{T}_1$)	12.32	18.60	5.68	9678.90	0.326
Nickel ($^{63}\text{Ni}_{28}$)	101.20	65.87	17.13	56.11	0.006
Krypton ($^{85}\text{Kr}_{36}$)	10.75	687.00	250.51	391.43	0.110
Strontium ($^{90}\text{Sr}_{38}$)	28.90	546.00	195.80	137.54	0.160
Ruthenium ($^{106}\text{Ru}_{44}$)	1.02	39.40	10.03	3313.11	0.197

[0037] The semiconductor device **116** includes a first-type extrinsic semiconductor **118** and a second-type semiconductor **120**. The first-type extrinsic semiconductor **118** surrounds the beta-particles source **114**. In one or more non-limiting embodiments, the first-type extrinsic semiconductor **118** is separated from the beta-particles source **114** to define an annular gap **119** therebetween. The second-type extrinsic semiconductor **120** surrounds the first-type extrinsic semiconductor **118** and the beta-particles source **114**. Accordingly, energetic beta particles **115** emitted from the decay of radioactive isotopes from the beta-particles source **114** impinge on the semiconductor device **116** and generate electron-hole pairs by impact ionization to create multiple electron-hole pairs through a series of interaction. Accordingly, the electron-hole pairs diffuse to the depletion region of the p-n junction **121** such that the of the semiconductor device **116** can convert energy produced from radioisotope beta-decay to electricity.

[0038] When the n-type semiconductor **120** is coupled with p-type semiconductor **118**, the free electrons from n-type semiconductor **120** move or “jump” to fill the holes in the p-type semiconductor **118**. As a result, a depletion region **123** is formed in the p-n junction **121**, e.g. between the n-type semiconductor **120** and the p-type semiconductor **118**. In other words, the p-n junction **121** becomes a depletion zone **123** due to the movement of the electrons and formation of holes. In the depletion region **123**, the layer where electrons leave now has a positive charge and the layer where electrons migrate now have negative charge.

[0039] The first-type and second-type semiconductors **118** and **120** each operate according to a lower energy level of a semiconductor referred to as the valence band (EV) and an higher energy level at which an electron can be considered free is called the conduction band (EC). The excitation of an electron to the conduction band leaves behind an empty space for an electron. An electron from a neighboring atom in the crystal lattice can move into this empty space. When this electron moves, it leaves behind another space (e.g., a hole). The continual movement of the space for an electron, called a ‘hole’, is effected by the movement of a positively charged particle through the crystal lattice structure of the semiconductor material. Consequently, the excitation of an electron into the conduction band results in not only an electron (e⁻) in the conduction band but also a hole (h⁺) in the valence band. The hole signifies absence of an electron (e⁻) in the semiconductor crystal lattice. Thus, both the electron (e⁻) and hole (h⁺) can participate in conduction and are called “carriers.”

[0040] In one or more non-limiting embodiments, the p-type semiconductor **118** and/or the n-type semiconductor **120** can be doped with additional impurity atoms (typically referred to as “dopants”) to increase the number of free

electrons and holes in order to increase the battery’s conversion efficiency. For example, the p-type semiconductor **118** (e.g., GaN, SiC, etc.) can be doped with three (3) valance-electrons atom such as Boron (B), Aluminum (Al), Gallium (Ga), and Indium (In), and the n-type semiconductor **120** (GaN or N-type SiC) can be doped with five (5) valence-electrons atom such as Phosphorus (P), Arsenic (As), and Antimony (Sb). The p-type semiconductor **118** may be referred to as having “free holes” (h⁺), while the n-type semiconductor **120** may be referred to as having “extra free electrons.”

[0041] In one or more non-limiting embodiments, the first-type extrinsic semiconductor **118** is a p-type semiconductor and the second-type extrinsic semiconductor **120** is an n-type semiconductor. Accordingly, the p-type semiconductor **118** and n-type semiconductor **120** can be coupled together to define a p-n junction **121**.

[0042] Various wide bandgap (WBG) semiconductors can be used to implement the p-type semiconductor **118** and n-type semiconductor **120**. Materials used to implement the p-type semiconductor **118** and n-type semiconductor **120** include, but are not limited to, silicon carbide (SiC), gallium nitride (GaN) and zinc oxide (ZnO). Table 2 below compares a baseline bandgap energy of silicon (Si) versus the various examples of WBG materials that can be utilized in the betavoltaic battery **102** to increase the conversion efficiency of the betavoltaic battery **102**.

TABLE 2

Semiconductor	Silicon (Si) Baseline Intrinsic Semiconductor	Wide bandgap (WBG) Semiconductors		
		Silicon Carbide (SiC)	Gallium Nitride (GaN)	Zinc Oxide (ZnO)
Bandgap (BG) in eV	1.12	3.26	3.39	3.37
Density (grams/cm ³)	2.33	3.22	6.16	5.60

[0043] A baseline BG as described herein refers to the energy required for electrons and holes to transition from the valence band to the conduction band. Silicon (Si), for example, has a band gap of 1.12 eV (electron volt), and is utilized herein as baseline reference value. The BG energy is the minimum amount of energy required for an electron to break free of its bound state and when this BG energy is met, the electron is excited into a free state and, hence, can participate in conduction. A hole is created where the electron was formerly bound, and this hole also participates in conduction.

[0044] A semiconductor with a wide BG value is referred to herein as a WBG semiconductor. Empirically, the average energy of one electron-hole pairs generation is equal to

2.8Eg+0.5 eV. That relationship indicates that the energy conversion efficiency increases with the bandgap. Accordingly, the wide bandgap semiconductors (examples are provided in Table 2) offer large conversion efficiency from the kinetic energy of the emitted electrons to electricity. A doped n-type semiconductor material is an extrinsic semiconductor that has been doped so that the majority carriers are electrons. A doped p-type material is an extrinsic semiconductor that has been doped so that the majority carriers are holes. When electrons cross from the n-type material to the p-type material, they leave positive charge and when the holes move to the n-type material, they leave a layer of negative charges.

[0045] In one or more non-limiting embodiments, the p-type and n-type extrinsic semiconductors **118** and **120** include a porous structure (e.g., a porous solid-state semiconductor material) to maximize the surface area exposed to collisions by the energetic electrons (namely, the β -particles) emitted from the radioactive source **114**. Accordingly, the p-type and n-type extrinsic semiconductors **118** and **120** can increase the effective surface area of the semiconductor device **116** and, thus, improving isotope source conversion efficiency of the betavoltaic battery **102** to provide a higher power density.

[0046] The radioactive shield housing **122** surrounds the second-type extrinsic semiconductor **118**, the first-type extrinsic semiconductor **118**, and the beta-particles source **114**. The radioactive shield housing defines the sidewalls **104**, the upper surface **106** and the lower surface **108** of the betavoltaic battery **102**. The radioactive shield housing **122** includes a radiation-resistant material including, but not limited to lead (Pb), aluminum (Al), tungsten (W), tantalum (Ta). In one or more non-limiting embodiments, a thin layer of high-density polyethylene (HDPE) is deposited on an outer surface of the radioactive shield housing **122** to protect the radioactive shield housing (e.g., the lead or aluminum, tungsten, or tantalum sheet) from potential mechanical impact damage.

[0047] As described herein, one or more non-limiting embodiments provide a RTG system that includes direct conversion betavoltaic (BV) battery capable of generating electricity and heat to support LEO as well as deep space applications. As the emitted electrons from the isotope source collide with the semiconductor materials, thermal energy is deposited in the crystal lattice of the semiconductor which heats the crystal. This thermal energy can be transferred (via conductive and radiative heat transfer modes) to the power electronic circuit powered by the betavoltaic battery. The BV battery includes a wide-bandgap (WBG), porous solid-state semiconductor device that is protected by a radiation-resistant housing, which allows the BV battery to outperform traditional solar photovoltaic cells due to their inability to function when the spacecraft orbits pass through radiation belts and during long periods of darkness.

[0048] The terminology used herein is for the purpose of describing particular embodiments only and is not intended to be limiting of the present disclosure. As used herein, the singular forms “a”, “an” and “the” are intended to include the plural forms as well, unless the context clearly indicates otherwise. It will be further understood that the terms “comprises” and/or “comprising,” when used in this specification, specify the presence of stated features, integers, steps, operations, elements, and/or components, but do not

preclude the presence or addition of one or more other features, integers, steps, operations, element components, and/or groups thereof.

[0049] While the present disclosure has been described with reference to an exemplary embodiment or embodiments, it will be understood by those skilled in the art that various changes may be made and equivalents may be substituted for elements thereof without departing from the scope of the present disclosure. In addition, many modifications may be made to adapt a particular situation or material to the teachings of the present disclosure without departing from the essential scope thereof. Therefore, it is intended that the present disclosure not be limited to the particular embodiment disclosed as the best mode contemplated for carrying out this present disclosure, but that the present disclosure will include all embodiments falling within the scope of the claims.

What is claimed is:

1. A radiation-to-generator (RTG) system comprising:
 - a betavoltaic battery including sidewalls extending between an upper surface and a bottom surface, the upper and bottom surfaces extending radially about a center axis to define a cylindrical profile; and
 - an external power electronic system connected to the betavoltaic battery,
 wherein the betavoltaic battery is configured to convert energy produced from radioisotope beta-decay to electricity that is configured to power the external power electronic system.
2. The RTG system of claim 1, wherein the betavoltaic battery comprises:
 - a beta-particles source extending along a center axis from a first end to an opposing second end;
 - a semiconductor device including a first-type extrinsic semiconductor surrounding the beta-particles source, and a second-type extrinsic semiconductor surrounding the first-type extrinsic semiconductor and the beta-particles source; and
 - a radioactive shield housing surrounding the second-type extrinsic semiconductor, the first-type extrinsic semiconductor, and the beta-particles source,
3. The RTG system of claim 2, wherein the radioactive shield housing includes sidewalls extending between an upper surface and a bottom surface, the upper and bottom surfaces extending radially about a center axis to define a cylindrical configuration of the betavoltaic battery.
4. The RTG system of claim 2, wherein the first-type extrinsic semiconductor is a p-type semiconductor and the second-type extrinsic semiconductor is an n-type semiconductor.
5. The RTG system of claim 4, wherein the first-type extrinsic semiconductor separated from the beta-particles source to define an annular gap therebetween.
6. The RTG system of claim 5, wherein the second-type extrinsic semiconductor is coupled to the first-type extrinsic semiconductor to define a p-n junction.
7. The RTG system of claim 6, wherein the first-type extrinsic semiconductor and the second-type extrinsic semiconductor each include a porous structure to receive electron collisions.
8. The RTG system of claim 7, wherein the first-type extrinsic semiconductor and the second-type extrinsic semiconductor are each doped with impurity atoms.

9. The RTG system of claim 5, wherein the radioactive shield housing includes a thin layer of high-density polyethylene (HDPE) deposited on an outer surface thereof.

10. The RTG system of claim 2, wherein the betavoltaic battery further comprising a first electrode that is electrically connected to the first-type extrinsic semiconductor and an input of the external power electronic system, and a second electrode that is electrically connected to the second-type extrinsic semiconductor and an output of the external power electronic system.

11. The RTG system of claim 2, wherein the beta-particles source includes a beta emitter nuclear isotope characterized by a long half-life to provide long service life of the battery suitable for space applications.

12. The RTG system of claim 11, wherein the beta emitter nuclear isotope produces electrons in response to realizing radioisotope beta-decay, and wherein the betavoltaic battery converts kinetic energy of the electrons to the electricity.

13. The RTG system of claim 1, wherein the power electronic system comprises a data communication system.

14. A betavoltaic battery comprising:

a beta-particles source extending along a center axis from a first end to an opposing second end;

a semiconductor device including a first-type extrinsic semiconductor surrounding the beta-particles source, and a second-type extrinsic semiconductor surrounding the first-type extrinsic semiconductor and the beta-particles source; and

a radioactive shield housing surrounding the second-type extrinsic semiconductor, the first-type extrinsic semiconductor, and the beta emitter nuclear isotope, the radioactive shield housing including sidewalls extending between an upper surface and a bottom surface, the upper and bottom surfaces extending radially about a center axis to define a profile of the betavoltaic battery.

15. The betavoltaic battery of claim 14, wherein the radioactive shield housing includes circular sidewalls extending between an upper surface and a bottom surface.

16. The betavoltaic battery of claim 14, wherein the first-type extrinsic semiconductor is a p-type semiconductor and the second-type extrinsic semiconductor is an n-type semiconductor.

17. The betavoltaic battery of claim 16, wherein the first-type extrinsic semiconductor separated from the beta-particles source to define an annular gap therebetween.

18. The betavoltaic battery of claim 17, wherein the second-type extrinsic semiconductor is coupled to the first-type extrinsic semiconductor to define a p-n junction.

19. The betavoltaic battery of claim 18, wherein the first-type extrinsic semiconductor and the second-type extrinsic semiconductor each include a porous structure to receive electron collisions.

20. The betavoltaic battery of claim 19, wherein the first-type extrinsic semiconductor and the second-type extrinsic semiconductor are each doped with impurity atoms.

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